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File Docket No. 107300

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 Yes No

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4. A. If this document is being filed together with a new application, the execution date of the application is: December 5, 2000

B. Patent Application No.(s) _____ C. Patent No.(s) _____

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5. Name and address of party to whom correspondence concerning document should be mailed:

Name: James A. Oliff

Address: **OLIFF & BERRIDGE, PLC**
P.O. Box 19928
Alexandria, VA 22320

6. Total number of applications and patents involved: 1

7. A. Total fee (37 CFR 3.41).....\$ 40.00
B. Enclosed (Check No. 114891)

8. Credit any overpayment or charge any underpayment to deposit account number 15-0461.

9. **Statement and signature.**
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

James A. Oliff
James A. Oliff, Registration No. 27,075
Joel S. Armstrong, Registration No. 36,430

Date: December 21, 2000

Total number of pages including cover sheet, attachments, and document: 3

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山田 陽一 は、

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Assignment

For good and valuable consideration, the receipt of which is hereby acknowledged, I/WE, the undersigned,

Yoichi YAMADA,

who have created a certain invention for which an application for United States Letters Patent

- executed by ME/US on even date herewith,
- executed by ME/US on _____, (respectively),
- filed on _____ and assigned Serial No. _____,
- filed as International Application No. _____ filed on _____

and entitled:

SEMICONDUCTOR INTEGRATED CIRCUIT

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Agree that Seiko Epson Corporation, hereinafter referred to as Assignee, may apply for and receive Letters Patent for said invention and said inventions, hereinafter referred to as said invention, in its own name, in the United States, its territorial possessions, and all foreign countries; and that, when requested to carry out in good faith the intent and purpose of this assignment, at the expense of said Assignee, its successors, assigns and legal representatives, the undersigned will execute all continuations-in-part, continuations, divisions, substitutes, reissues, extensions thereof, execute all rightful oaths, assignments, powers of attorney and other papers, testify in any legal or quasi legal proceedings; communicate to said Assignee, its successors, assigns or legal representatives all facts known to the undersigned relating to said invention and the history thereof; and generally do everything possible which said Assignee, its successors, assigns, or legal representatives shall consider desirable for aiding in securing, maintaining and enforcing proper patent protection for said invention and for vesting title to said invention and all applications for patents on said invention in said Assignee, its successors, assigns, or legal representatives; and

